

T635T-8T

6 A Snubberless™ Triac

Datasheet – production data

Features

- Medium current Triac
- High static and dynamic commutation
- Three quadrants
- ECOPACK[®]2 compliant component

Applications

- General purpose AC line load switching
- Motor control circuits
- Small home appliances
- Lighting
- Inrush current limiting circuits
- Overvoltage crowbar protection

Description

Available in through-hole package, the T635T-8T Triac can be used for the on/off or phase angle control function in general purpose AC switching where high commutation capability is required. This device can be used without a snubber circuit when the limits defined in this datasheet are respected.

TM: Snubberless is a trademark of STMicroelectronics

 $V_{\text{DSM}}, V_{\text{RSM}}$

 I_{GT}

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Unit

А

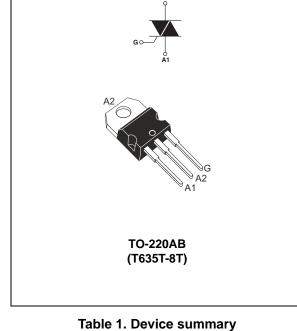
V

V

mΑ

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This is information on a product in full production.



I_{T(rms)} 6 V_{DRM}, V_{RRM} 800

900

35

Symbol Value

1 Characteristics

Symbol	Paramete	Value	Unit			
I _{T(rms)}	On-state rms current (full sine wave	state rms current (full sine wave)		6	А	
I	Non repetitive surge peak on-state $F = 50$		t = 20 ms	45	А	
I _{TSM}	current (full cycle, T_j initial = 25 °C)	F = 60 Hz	t = 16.7 ms	47	~	
l ² t	$I^{2}t$ value for fusing, T_{j} initial = 25 °C		t _p = 10 ms	13	A²s	
V _{DRM} ,	Repetitive surge peak off-state volta	T _j = 150 °C	600	V		
V _{RRM}	Repetitive surge peak off-state voltage		T _j = 125 °C	800	v	
V _{DSM} , V _{RSM}	Non repetitive surge peak off-state	petitive surge peak off-state voltage		900	V	
dl/dt	Critical rate of rise of on-state current I_G = 2 x I_{GT} , $t_r \le 100$ ns	F = 100 Hz		100	A/µs	
I _{GM}	Peak gate current	t _p = 20 μs	T _j = 150 °C	4	А	
P _{G(AV)}	Average gate power dissipation	1	W			
T _{stg} T _j	Storage junction temperature range Operating junction temperature range			- 40 to + 150 - 40 to + 150	°C	
TL		Maximum lead temperature for soldering during 10 s			°C	
V _{ins}	Insulation rms voltage, 1 minute		1500	V		

Table 2. Absolute maximum ratings (T	Γ _i = 25 °C unless otherwise stated)
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Table 3. Electrical characteristics ($T_i = 25 \text{ °C}$, unless otherwise stated)

Symbol	Test conditions Quadrant			Value	Unit	
I _{GT} ⁽¹⁾	$V_{\rm D} = 12 \text{ V}, \text{ R}_{\rm I} = 30 \Omega$	1 - 11 - 111	Min.	1.75	m۸	
'GT`´	$V_{\rm D} = 12$ V, $R_{\rm L} = 30.02$	1 - 11 - 111	Max.	35	mA	
V _{GT}	$V_D = 12 \text{ V}, \text{ R}_L = 30 \Omega$	1 - 11 - 111	Max.	1.3	V	
V_{GD}	$V_{D} = V_{DRM}, R_{L} = 3.3 \text{ k}\Omega, T_{j} = 150 \text{ °C}$ I - II - III		Min.	0.2	V	
I _H ⁽¹⁾	I _T = 500 mA		Max.	40	mA	
١L	$I_{G} = 1.2 I_{GT}$	1 - 111	Max.	60	mA	
۲L	IG = 1.2 IGT	II	Max.	65	mA	
dV/dt ⁽¹⁾	V _D = 536 V, gate open	T _j = 125 °C	Min	2000	V/µs	
uv/dl V	V _D = 402 V, gate open	T _j = 150 °C	T _j = 150 °C		V/µs	
(dl/dt)c ⁽¹⁾	Without snubber (dV/dt)c \ge 20 V/µs)	T _j = 125 °C	Min.	6	A/ms	
		T _j = 150 °C		3	A/IIIS	

1. For both polarities of A2 referenced to A1



2/9

Symbol	Test conditions			Value	Unit
V _T ⁽¹⁾	$I_{TM} = 8.5 \text{ A}, t_p = 380 \ \mu \text{s}$	T _j = 25 °C	Max.	1.55	V
V _{t0} ⁽¹⁾	Threshold voltage	T _j = 150 °C	Max.	0.85	V
R _d ⁽¹⁾	Dynamic resistance	T _j = 150 °C	Max.	75	mΩ
	V _{DRM} = V _{RRM} = 800 V	T _j = 25 °C Max.	5	μA	
I _{DRM} I _{RRM}	$v_{\text{DRM}} = v_{\text{RRM}} = 800 v$	T _j = 125 °C		0.6	mA
'KKIM	$V_{DRM} = V_{RRM} = 600 V$	T _j = 150 °C	Max.	2.0	IIIA

Table 4. Static characteristics

1. For both polarities of A2 referenced to A1

Symbol	Parameter	Value	Unit
R _{th(j-c)}	Junction to case (AC)	2.1	°C/W
R _{th(j-a)}	Junction to ambient (DC)	60	°C/W

Figure 1. Maximum power dissipation versus on-state rms current (full cycle)

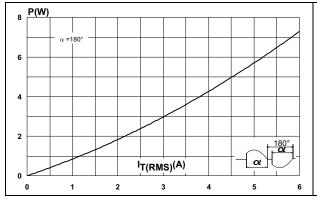
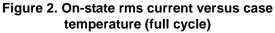


Figure 3. On-state rms current versus ambient temperature (free air convection)



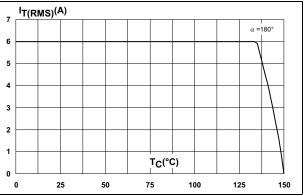
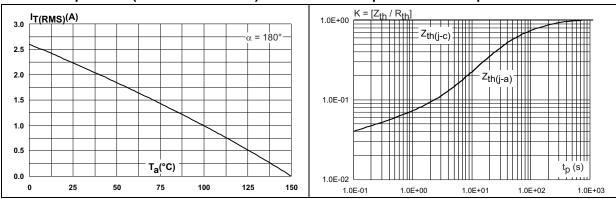


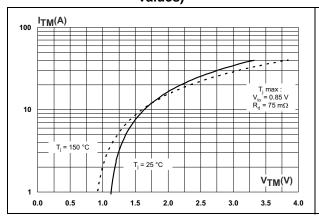
Figure 4. Relative variation of thermal impedance versus pulse duration





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Figure 5. On-state characteristics (maximum values)



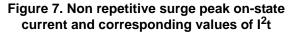




Figure 6. Surge peak on-state current versus

number of cycles

Non repetitive T_i initial=25 °C

10

ITSM(A)

Repetitive

T_c= 135 °C

50

45 40 35

30

25 20 15

10

5

0

1

Figure 8. Relative variation of gate trigger current and gate voltage versus junction temperature (typical values)

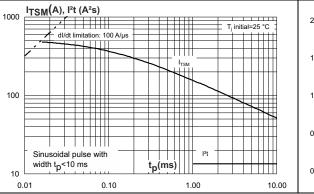


Figure 9. Relative variation of static dV/dt immunity versus junction temperature (typical values)

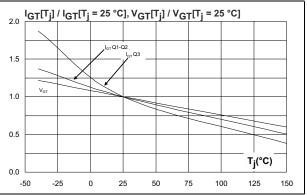
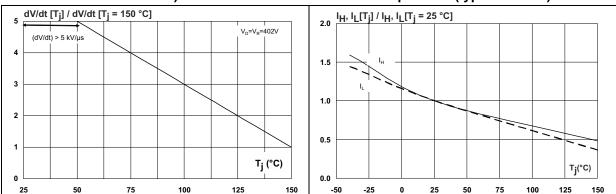


Figure 10. Relative variation of holding current and latching current versus junction temperature (typical values)



Number of cycles

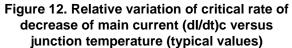
100

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1000



Figure 11. Relative variation of critical rate of decrease of main current (dl/dt)c versus reapplied (dV/dt)c (typical values)



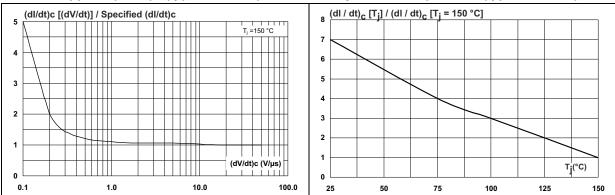
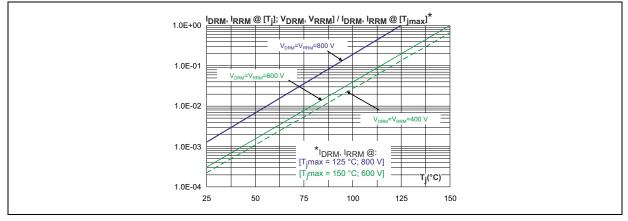


Figure 13. Relative variation of leakage current versus junction temperature for different values of blocking voltage (typical values)

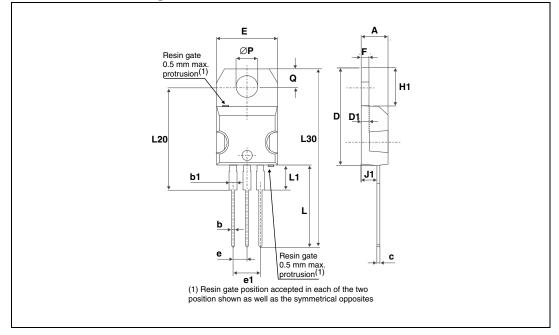


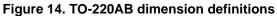


2 Package information

- Epoxy meets UL94, V0
- Lead-free package
- Recommended torque: 0.4 to 0.6 N·m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.







		Dimer	nsions		
Ref.	Millim	eters	Incl	hes	
	Min.	Max.	Min.	Max.	
А	4.40	4.60	0.17	0.18	
b	0.61	0.88	0.024	0.035	
b1	1.14	1.70	0.045	0.067	
С	0.48	0.70	0.019	0.027	
D	15.25	15.75	0.60 0.62		
D1	1.27	7 typ. 0.05 typ.			
E	10	10.40	0.39		
е	2.40	2.70	0.094	0.106	
e1	4.95	5.15	0.19	0.20	
F	1.23	1.32	0.048	0.052	
H1	6.20	6.60	0.24	0.26	
J1	2.40	2.72	0.094	0.107	
L	13	14	0.51	0.55	
L1	3.50	3.93	0.137	0.154	
L20	16.40 typ.		0.64	typ.	
L30	28.90	typ.	1.13	typ.	
ØP	3.75	3.85	0.147	0.151	
Q	2.65	2.95	0.104	0.116	

Table 6. TO-220AB dimension values



3 Ordering information

Triac	i	6	35 	т.	8	i
Current 6 = 6 A						
Gate sensitivity						
35 = 35 mA						
Specific application						
T = Increased (dl/dt)c and dV/dt producing reduced I_{TS}	SM					
Voltage (V _{DRM} , V _{RRM})						
8 = 800 V						
Deskage						
Package T = TO-220AB						

Figure 15. Ordering information scheme

Table 7. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
T635T-8T	T635T-8T	TO-220AB	2.0 g	50	Tube

4 Revision history

Date	Revision	Changes
05-Aug-2013	1	Initial release.



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